Electronic Patent Application Fee Transmittal							
Application Number:	10:	10561381					
Filing Date:	16-Dec-2005						
Title of Invention:	Lead frame routed chip pads for semiconductor packages						
First Named Inventor/Applicant Name:	Shafidul Islam						
Filer:	Jay H. Anderson./Brenda Musco						
Attorney Docket Number:	102423-108						
Filed as Large Entity							
U.S. National Stage under 35 USC 371 Filing Fees							
Description		Fee Code	Quantity	Amount	Sub-Total in USD(\$)		
Basic Filing:							
Pages:							
Claims:							
Miscellaneous-Filing:							
Petition:							
Patent-Appeals-and-Interference:							
Post-Allowance-and-Post-Issuance:							
Extension-of-Time:							

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Miscellaneous:				
Request for continued examination	1801	1	810	810
	Tot	810		